TOSHIBA Bipolar Linear Integrated Circuit Silicon Monolithic

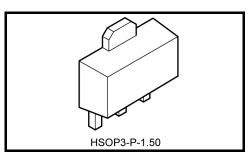
# TA76431F,TA76431FR

## Adjustable Precision Shunt Regulator

### **Features**

- Precision Reference Voltage:  $V_{REF} = 2.495 \text{ V} \pm 2.2\%$
- Small Temperature Coefficient: | αV<sub>REF</sub>| = 46 ppm/°C
- Adjustable Output Voltage:  $V_{REF} \le V_{OUT} \le 36 \text{ V}$
- Low Dynamic Output Impedance:  $|Z_{KA}| = 0.15 \Omega$  (Typ.)
- Small Flat Package
- TA76431FR is a new Toshiba shunt regulator.

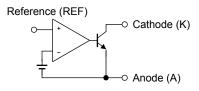
  This device's pin assignment is the reverse of that of the TA76431F.

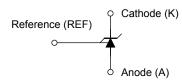


Weight: 0.05 g (typ.)

## **Functional Block Diagram**

## **Circuit Symbol**

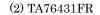


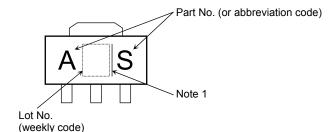


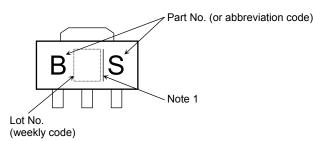
This IC contains electrostatic sensitive elements. Please take care to avoid generating static electricity when handling these devices.

### Marking

(1) TA76431F







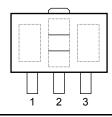
Note 1: A line beside a Lot No. identifies the indication of product Labels.

Without a line: [[Pb]]/INCLUDES > MCV

With a line: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

### Pin Assignment

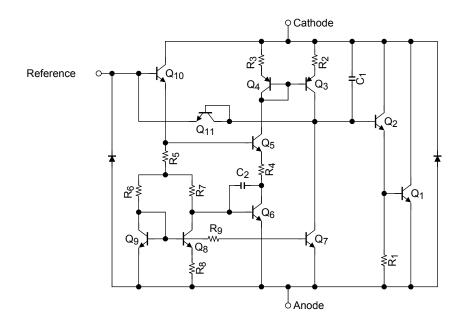


No.	(1) TA76431F	(2) TA76431FR
1	Cathode (K)	Reference (REF)
2	Anode (A)	Anode (A)
3	Reference (REF)	Cathode (K)

### **How to Order**

No.	Product No.	Package Type	Packing Type	Minimum Order
(1)	TA76431F		On cut tape (TE12L): 100 pcs/tape section	100
(1)	TA76431F (TE12L)	PW-Mini (SOT-89) (surface-mount type)	Embossed tape: 1000 pcs/tape	1 tape
(2)	TA76431FR	(Surface-mount type)	On cut tape (TE12L): 100 pcs/tape section	100
(2)	TA76431FR (TE12L)		Embossed tape: 1000 pcs/tape	1 tape

## **Equivalent Circuit**



## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit	
Cathode voltage	$V_{KA}$	37	V	
Cathode current	lκ	-100 to 150	mA	
Reference voltage	$V_{REF}$	7	V	
Reference current	I <sub>REF</sub>	50	μΑ	
Reference-anode reverse current	-I <sub>REF</sub>	10	mA	
Power dissination	D-	500	mW	
Power dissipation	P <sub>D</sub>	1000 (Note 2)	11100	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Storage temperature	T <sub>stg</sub>	-55 to 150	°C	

Note 2: Mounted on ceramic substrate (250 mm<sup>2</sup> × 0.8 mm (t))

Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



## **Operating Ranges**

Characteristics	Symbol	Min	Тур.	Max	Unit
Cathode voltage	V <sub>KA</sub>	$V_{REF}$	_	36	V
Cathode current	lκ	1	_	100	mA
Operating temperature	T <sub>opr</sub>	-40		85	°C

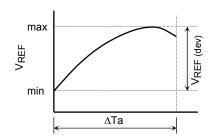
# Electrical Characteristics (Unless otherwise specified, Ta = 25°C, $I_K = 10$ mA)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reference voltage	$V_{REF}$	V <sub>KA</sub> = V <sub>REF</sub>	2.440	2.495	2.550	V
Deviation of reference input voltage over temperature	V <sub>REF</sub> (dev)	$0^{\circ}C \le Ta \le 70^{\circ}C$ , $V_{KA} = V_{REF}$	_	8	17	mV
Ratio of change in reference input	ΔV <sub>REF</sub> /ΔV	V <sub>REF</sub> ≤ V <sub>KA</sub> ≤ 10 V	_	0.8	2.7	mV/V
voltage to the change in cathode voltage		10 V ≤ V <sub>KA</sub> ≤ 36 V	_	0.5	2.0	
Reference Input current	I <sub>REF</sub>	V <sub>KA</sub> = V <sub>REF</sub>	_	1.4	4	μА
Deviation of reference input current over temperature	I <sub>REF (dev)</sub>	$ \begin{array}{l} 0^{\circ}C \leq Ta \leq 70^{\circ}C, \ V_{KA} = V_{REF}, \\ R_{1} = 10 \ k\Omega, \ R_{2} = \infty \end{array} $	_	0.3	1.2	μА
Minimum cathode current for regulation	I <sub>Kmin</sub>	V <sub>KA</sub> = V <sub>REF</sub>	_	0.4	1.0	mA
Off-State cathode current	I <sub>Koff</sub>	$V_{KA} = 36 \text{ V}, V_{REF} = 0 \text{ V}$	_	_	1.0	μА
Dynamic impedance	Z <sub>KA</sub>	$V_{KA} = V_{REF}, f \le 1 \text{ kHz},$ 1 mA $\le I_K \le 100 \text{ mA}$	_	0.15	0.5	Ω

The deviation parameters  $V_{REF}$  (dev) and  $I_{REF}$  (dev) are defined as the maximum variation of the  $V_{REF}$  and  $I_{REF}$  over the rated temperature range.

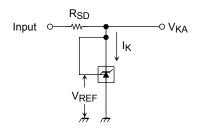
The average temperature coefficient of the  $\ensuremath{V_{REF}}$  is defined as:

$$\left|\alpha V_{REF}\right| = \frac{\left(\frac{V_{REF} (dev)}{V_{REF} @25^{\circ}C}\right) \times 10^{6}}{\Delta Ta} (ppm/^{\circ}C)$$

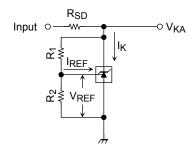


## **Test Parameter**

## (1) $V_{KA} = V_{REF}$ Mode

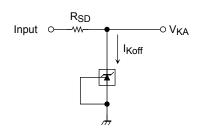


## (2) V<sub>KA</sub> > V<sub>REF</sub> Mode



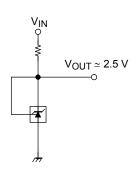
$$V_{KA} = V_{REF} \left( 1 + \frac{R_1}{R_2} \right) + I_{REF} \cdot R_1$$

## (3) OFF-State Mode

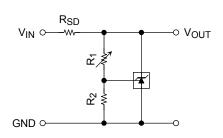


## **Typical Application Circuits**

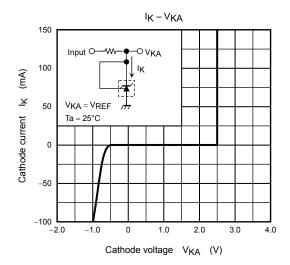
## (1) 2.5 V Reference

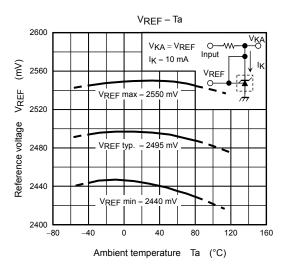


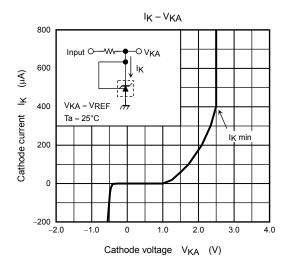
## (2) Shunt Regulator

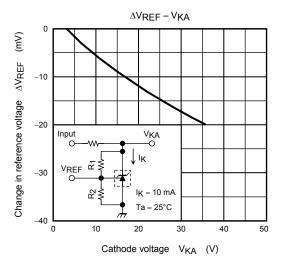


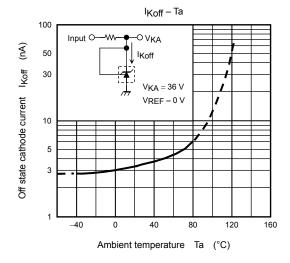
$$V_{OUT} = V_{REF} \left( 1 + \frac{R_1}{R_2} \right) + I_{REF} \cdot R_1$$

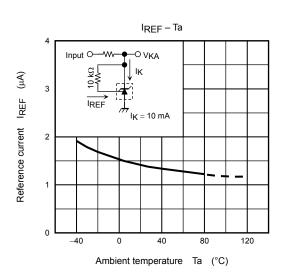


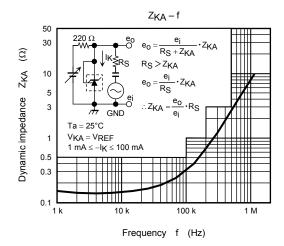


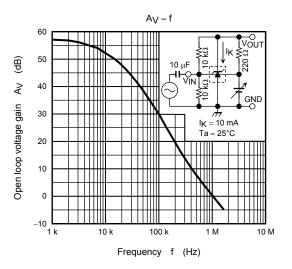


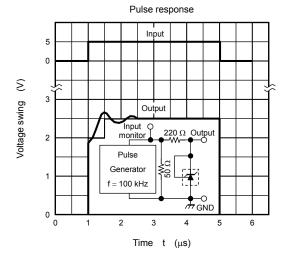


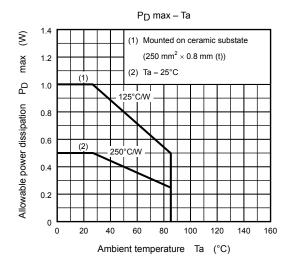


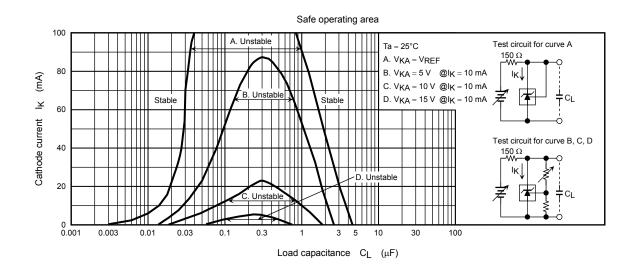










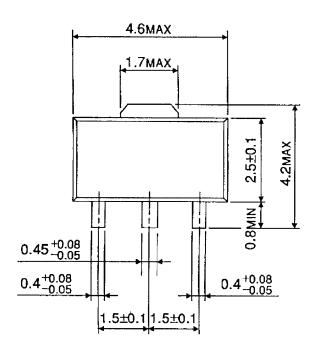


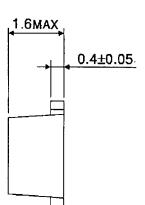
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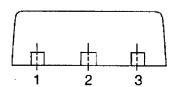
Unit: mm

# **Package Dimensions**

HSOP3-P-1.50







Weight: 0.05 g (typ.)

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